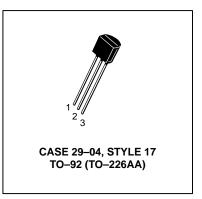
Amplifier Transistors NPN Silicon

MAXIMUM RATINGS

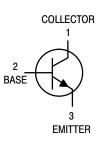
Rating	Symbol	BC237	BC238	BC239	Unit
Collector–Emitter Voltage	V _{CEO}	45	25	25	Vdc
Collector–Emitter Voltage	V _{CES}	50	30	30	Vdc
Emitter-Base Voltage	V _{EBO}	6.0 5.0		5.0	Vdc
Collector Current — Continuous	Ι _C	100		mAdc	
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	350 2.8		mW mW/°C	
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	1.0 8.0		Watts mW/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	–55 to +150 °C		°C	





THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient	R_{\thetaJA}	357	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	125	°C/W



ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

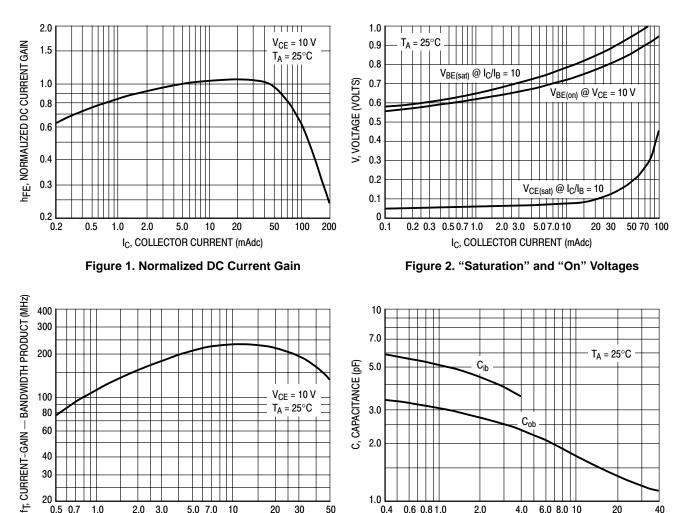
Characteristic		Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS						
Collector–Emitter Breakdown Voltage $(I_{C} = 2.0 \text{ mA}, I_{B} = 0)$	BC237 BC238 BC239	V _{(BR)CEO}	45 25 25			V
Emitter–Base Breakdown Voltage ($I_E = 100 \ \mu A, I_C = 0$)	BC237 BC238 BC239	V _{(BR)EBO}	6.0 5.0 5.0			V
Collector Cutoff Current ($V_{CE} = 30 \text{ V}, V_{BE} = 0$)	BC238 BC239	ICES		0.2 0.2	15 15	nA
(V _{CE} = 50 V, V _{BE} = 0) (V _{CE} = 30 V, V _{BE} = 0) T _A = 125°C	BC237 BC238		_	0.2 0.2	15 4.0	μA
	BC239		_	0.2	4.0	μΛ
$(V_{CE} = 50 \text{ V}, V_{BE} = 0) \text{ T}_{A} = 125^{\circ}\text{C}$	BC237		_	0.2	4.0	

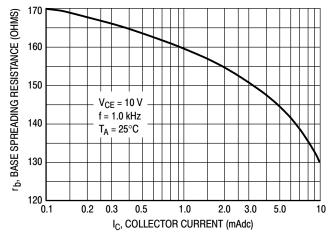
BC237,A,B,C BC238B,C BC239,C

Characteristic		Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS						
DC Current Gain (I _C = 10 μ A, V _{CE} = 5.0 V)	BC237A BC237B/238B BC237C/238C/239C	h _{FE}		90 150 270		_
(I _C = 2.0 mA, V _{CE} = 5.0 V)	BC237 BC239 BC237A BC237B/238B BC237C/238C/239C		120 120 120 200 380	— 170 290 500	800 800 220 460 800	
$(I_{C} = 100 \text{ mA}, V_{CE} = 5.0 \text{ V})$	BC237A BC237B/238B BC237C/238C/239C			120 180 300		
Collector–Emitter On Voltage ($I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$) 39 ($I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA}$)	BC237/BC238/BC2 BC237/BC239 BC238	V _{CE(sat)}		0.07 0.2	0.2 0.6 0.8	V
Base–Emitter Saturation Voltage ($I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$) ($I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA}$)		V _{BE(sat)}		0.6	0.83 1.05	V
$\begin{array}{l} \text{Base-Emitter On Voltage} \\ (I_{C} = 100 \ \mu\text{A}, \ V_{CE} = 5.0 \ \text{V}) \\ (I_{C} = 2.0 \ \text{mA}, \ V_{CE} = 5.0 \ \text{V}) \\ (I_{C} = 100 \ \text{mA}, \ V_{CE} = 5.0 \ \text{V}) \end{array}$		V _{BE(on)}	 0.55 	0.5 0.62 0.83	 0.7 	V
DYNAMIC CHARACTERISTICS						
Current–Gain — Bandwidth Product ($I_C = 0.5 \text{ mA}, V_{CE} = 3.0 \text{ V}, f = 100 \text{ MHz}$)	BC237 BC238 BC239	fT	 	100 120 140		MHz
(I _C = 10 mA, V _{CE} = 5.0 V, f = 100 MHz)	BC237 BC238 BC239		150 150 150	200 240 280		
Collector–Base Capacitance $(V_{CB} = 10 \text{ V}, I_C = 0, f = 1.0 \text{ MHz})$		C _{obo}	—	—	4.5	pF
Emitter–Base Capacitance $(V_{EB} = 0.5 \text{ V}, I_C = 0, f = 1.0 \text{ MHz})$		C _{ibo}	_	8.0	_	pF
Noise Figure (I _C = 0.2 mA, V _{CE} = 5.0 V, R _S = 2.0 kΩ, f = 1.0 kHz)	BC239	NF		2.0	4.0	dB
(I _C = 0.2 mA, V _{CE} = 5.0 V, R _S = 2.0 kΩ, f = 1.0 kHz, Δ f = 200 Hz)	BC237 BC238 BC239			2.0 2.0 2.0 2.0	4.0 10 10 4.0	

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

BC237, A, B, C BC238B, C BC239, C





2.0

1.0

0.4

50

0.6 0.8 1.0

2.0

4.0 6.0 8.0 10

V_R, REVERSE VOLTAGE (VOLTS)

Figure 4. Capacitances

20

40

40 30 20

0.5 0.7

1.0

3.0

2.0

5.0 7.0

IC, COLLECTOR CURRENT (mAdc) Figure 3. Current–Gain — Bandwidth Product

10

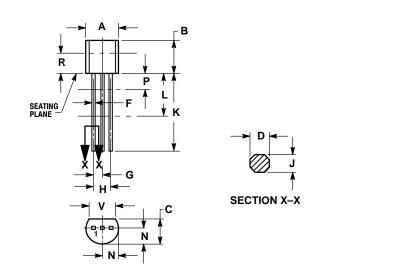
20 30

Figure 5. Base Spreading Resistance

BC237,A,B,C BC238B,C BC239,C

PACKAGE DIMENSIONS

CASE 029-04 (TO-226AA) ISSUE AD



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- CONTROLLING DIMENSION: INCH.
 CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.

A. DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.022	0.41	0.55	
F	0.016	0.019	0.41	0.48	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
Ρ		0.100		2.54	
R	0.115		2.93		
V	0.135		3.43		

STYLE 17: PIN 1. COLLECTOR 2. BASE 3. EMITTER

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